





#### 20V P-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max @ T <sub>A</sub> = +25°C (Note 5)
	495mΩ @ $V_{GS} = -4.5V$	-0.77A
-20V	690mΩ @ V <sub>GS</sub> = -2.5V	-0.67A
	960mΩ @ V <sub>GS</sub> = -1.8V	-0.57A

### **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, which makes it ideal for high-efficiency power management applications.

Portable Electronics

#### **Features and Benefits**

- Footprint of Just 0.6mm<sup>2</sup>—13 Times Smaller Than SOT23
- Low Gate Threshold Voltage
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- ESD Protected Gate
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

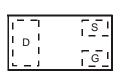
- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu Over Copper Leadframe. Solderable per MIL-STD-202, Method 208@4
- Weight: 0.001 grams (Approximate)



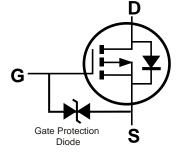




Bottom View



Top View Internal Schematic



**Equivalent Circuit** 

### **Ordering Information** (Note 4)

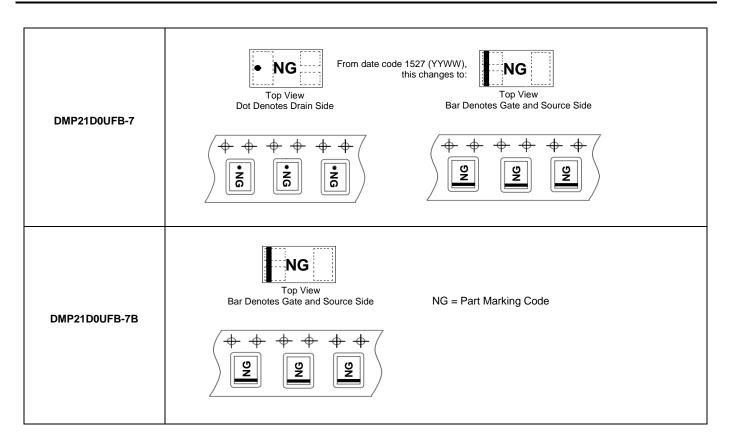
Part Number	Case	Packaging
DMP21D0UFB-7	X1-DFN1006-3	3,000/Tape & Reel
DMP21D0UFB-7B	X1-DFN1006-3	10,000/Tape & Reel

#### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, see https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**





## **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		$V_{DSS}$	-20	V	
Gate-Source Voltage		V <sub>GSS</sub>	±8	V	
Continuous Drain Current	Steady State V <sub>GS</sub> =-4.5V	$T_A = +25^{\circ}\text{C (Note 5)}$ $T_A = +85^{\circ}\text{C (Note 5)}$ $T_A = +25^{\circ}\text{C (Note 6)}$	l <sub>D</sub>	-0.77 -0.55 -1.17	А
Pulsed Drain Current (Note 7)		I <sub>DM</sub>	-5.0	Α	

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	0.43	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>OJA</sub>	293	°C/W
Power Dissipation (Note 6)	P <sub>D</sub>	0.99	W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>OJA</sub>	126	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### **Thermal Characteristics**

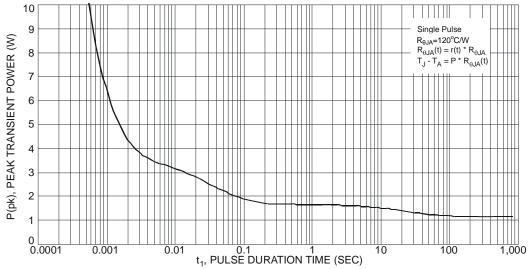
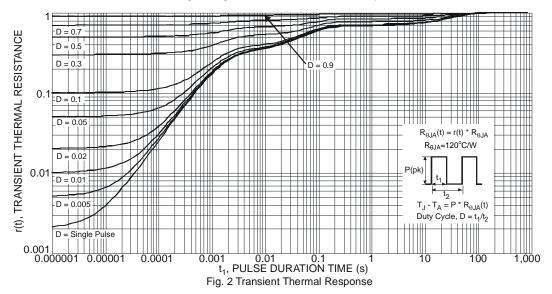


Fig. 1 Single Pulse Maximum Power Dissipation





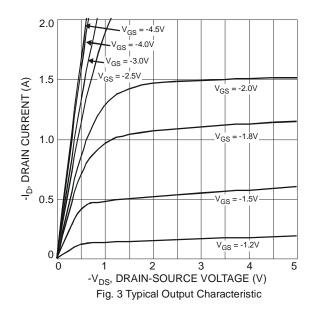
### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

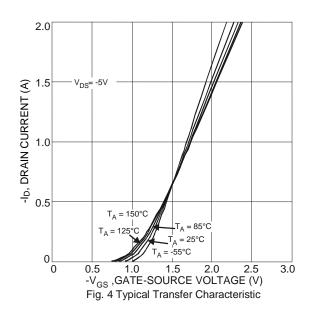
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	1	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current, T <sub>J</sub> = +25°C	I <sub>DSS</sub>	_	_	-1	μA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.5	-0.7	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
				495		$V_{GS} = -4.5V$ , $I_{D} = -400$ mA	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	_	690	mΩ	$V_{GS} = -2.5V, I_{D} = -300mA$	
	` ´	_	_	960		$V_{GS} = -1.8V, I_{D} = -100mA$	
Forward Transfer Admittance	Y <sub>fs</sub>	50	_	_	mS	$V_{DS} = -3V, I_{D} = -300 \text{mA}$	
Diode Forward Voltage	$V_{SD}$	_	_	-1.2	V	$V_{GS} = 0V, I_{S} = -300 \text{mA}$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>		76.5	_	pF	101/11/101/11	
Output Capacitance	Coss		13.7	_	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	10.7	_	pF		
Gate Resistance	$R_{g}$		195	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge	Qg	_	1.5	_	nC	$V_{GS} = -8V, V_{DS} = -15V, I_{D} = -1A$	
Total Gate Charge	$Q_{g}$	_	1.0	_	nC	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Gate-Source Charge	$Q_{gs}$	_	0.2	_	nC	$V_{GS} = -4.5V, V_{DS} = -15V,$ $I_{D} = -1A$	
Gate-Drain Charge	Q <sub>qd</sub>	_	0.3	_	nC		
Turn-On Delay Time	t <sub>D(ON)</sub>	_	7.1	_	ns	$V_{DS} = -10V, I_{D} = -1A$ $V_{GS} = -4.5V, R_{G} = 6\Omega$	
Turn-On Rise Time	t <sub>R</sub>	_	8.0	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	31.7	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	18.5		ns		

Notes:

- 5. Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
  6. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
  7. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.
  8. Short duration pulse test used to minimize self-heating effect.
  9. Guaranteed by design. Not subject to product testing.

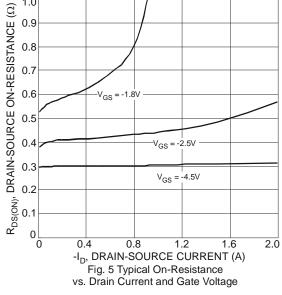
## **Typical Characteristics**

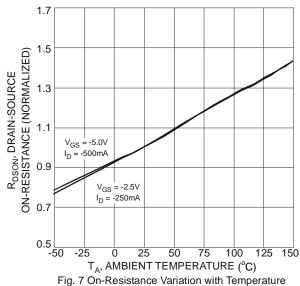


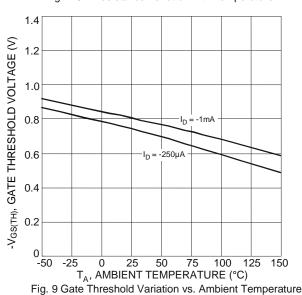


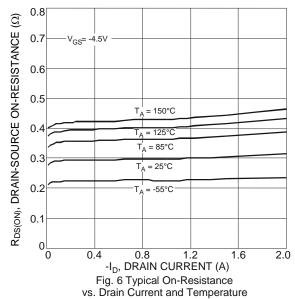


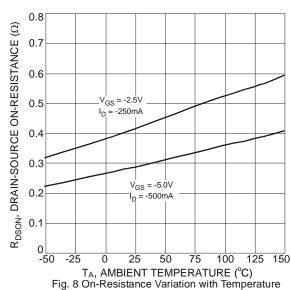


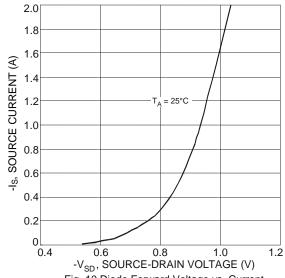




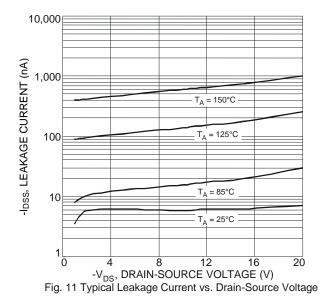


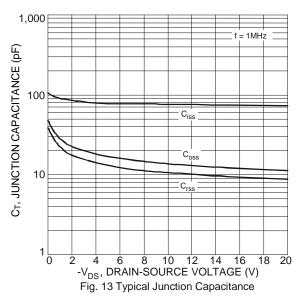


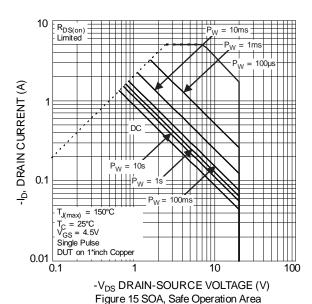


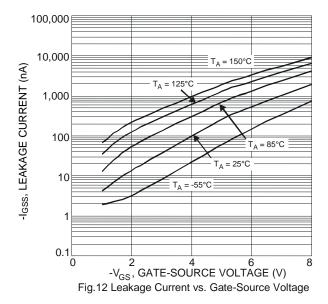


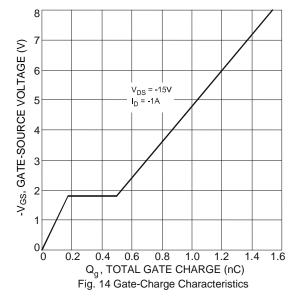










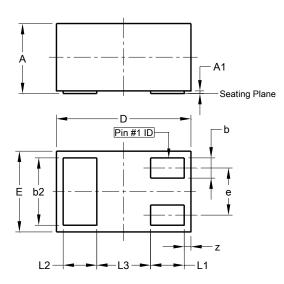




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1006-3

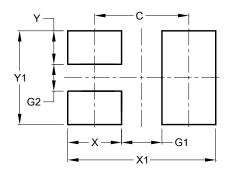


X1-DFN1006-3				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0.00	0.05	0.03	
b	0.10	0.20	0.15	
b2	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е	-	-	0.35	
L1	0.20	0.30	0.25	
L2	0.20	0.30	0.25	
L3	1	-	0.40	
Z	0.02	0.08	0.05	
All Dimensions in mm				

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X1-DFN1006-3



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Υ	0.25
Y1	0.70



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